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# NC7SP17

## TinyLogic® ULP Single Buffer with Schmitt Trigger Input

### Features

- 0.9V to 3.6V  $V_{CC}$  Supply Operation
- 3.6V Over-Voltage Tolerant I/Os at  $V_{CC}$  from 0.9V to 3.6V
- Propagation Delay ( $t_{PD}$ ):
  - 4.0ns Typical for 3.0V to 3.6V  $V_{CC}$
  - 5.0ns Typical for 2.3V to 2.7V  $V_{CC}$
  - 6.0ns Typical for 1.65V to 1.95V  $V_{CC}$
  - 7.0ns Typical for 1.40V to 1.60V  $V_{CC}$
  - 11.0ns Typical for 1.10V to 1.30V  $V_{CC}$
  - 27.0ns Typical for 0.90V  $V_{CC}$
- Power-Off High-Impedance Inputs and Outputs
- Static Drive ( $I_{OH}/I_{OL}$ ):
  - $\pm 2.6$ mA at 3.00V  $V_{CC}$
  - $\pm 2.1$ mA at 2.30V  $V_{CC}$
  - $\pm 1.5$ mA at 1.65V  $V_{CC}$
  - $\pm 1.0$ mA at 1.40V  $V_{CC}$
  - $\pm 0.5$ mA at 1.10V  $V_{CC}$
  - $\pm 20$  $\mu$ A at 0.9V  $V_{CC}$
- Quiet Series™ Noise / EMI Reduction Circuitry
- Ultra Small MicroPak™ Packages
- Ultra Low Dynamic Power

### Description

The NC7SP17 is a single buffer with Schmitt trigger input from Fairchild's Ultra Low Power (ULP) series of TinyLogic®. Ideal for applications where battery life is critical, this product is designed for ultra low power consumption within the  $V_{CC}$  operating range of 0.9V to 3.6V  $V_{CC}$ .

The internal circuit is composed of a minimum of inverter stages, including the output buffer, to enable ultra low static and dynamic power.

The NC7SP17, for lower drive requirements, is uniquely designed for optimized power and speed and is fabricated with an advanced CMOS technology to achieve best-in-class speed of operation, while maintaining extremely low CMOS power dissipation.

### Ordering Information

Part Number	Top Mark	Package	Packing Method
NC7SP17P5X	P17	5-Lead SC70, EIAJ SC-88a, 1.25mm Wide	3000 Units on Tape & Reel
NC7SP17L6X	K4	6-Lead MicroPak™, 1.00mm Wide	5000 Units on Tape & Reel
NC7SP17FHX	K4	6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch	5000 Units on Tape & Reel

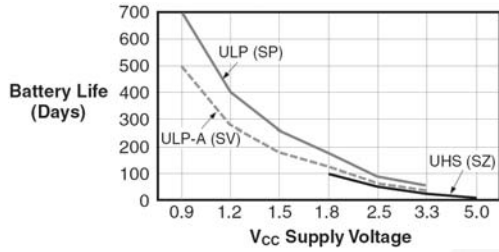


Figure 1. Battery Life vs. V<sub>CC</sub> Supply Voltage

**Notes:**

1. TinyLogic ULP and ULP-A with up to 50% less power consumption can extend battery life significantly.
2. Battery Life=(V<sub>battery</sub> × I<sub>battery</sub> × 0.9) / (P<sub>device</sub>) / 24hrs/day; where, P<sub>device</sub>=(I<sub>CC</sub> × V<sub>CC</sub>) + (C<sub>PD</sub> + C<sub>L</sub>) × V<sub>CC</sub><sup>2</sup> × f.
3. Assumes ideal 3.6V Lithium Ion battery with current rating of 900mAH and derated 90% and device frequency at 10MHz, with C<sub>L</sub>=15pF load.

**Connection Diagrams**



Figure 2. Logic Symbol

**Pin Configurations**

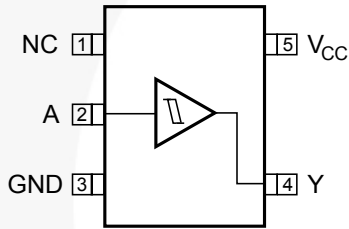


Figure 3. SC70 (Top View)

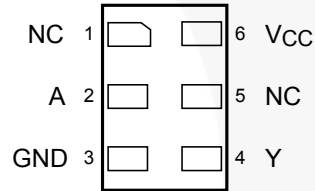


Figure 4. MicroPak™ (Top Through View)

**Function Table**

Y=A

Input	Output
A	Y
L	L
H	H

L = Low Logic Level  
H = High Logic Level

**Pin Definitions**

Pin # SC70	Pin # MicroPak	Name	Description
1	1, 5	NC	No Connect
2	2	A	Input
3	3	GND	Ground
4	4	Y	Output
5	6	V <sub>CC</sub>	Supply Voltage

## Absolute Maximum Ratings

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

Symbol	Parameter		Min.	Max.	Unit
$V_{CC}$	Supply Voltage		-0.5	4.6	V
$V_{IN}$	DC Input Voltage		-0.5	4.6	V
$V_{OUT}$	DC Output Voltage	HIGH or LOW State <sup>(4)</sup>	-0.5	$V_{CC}$ to +0.5	V
		$V_{CC}=0V$	-0.5	4.6	V
$I_{IK}$	DC Input Diode Current at $V_{IN} < 0V$			-50	mA
$I_{OK}$	DC Output Diode Current	$V_{OUT} < 0V$		-50	mA
		$V_{OUT} > V_{CC}$		+50	
$I_{OH} / I_{OL}$	DC Output Source/Sink Current			±50	mA
$I_{CC}$ or Ground	DC $V_{CC}$ or Ground Current per Supply Pin			±50	mA
$T_{STG}$	Storage Temperature Range		-65	+150	°C
$T_J$	Junction Temperature Under Bias			+150	°C
$T_L$	Junction Lead Temperature (Soldering, 10 Seconds)			+260	°C
$P_D$	Power Dissipation at +85°C	SC70-5		150	mW
		MicroPak™-6		130	
		MicroPak2™-6		120	
ESD	Human Body Model	JEDEC: JESD22-A114		4000	V
	Charged Device Model	JEDEC: JESD22-C101		2000	

**Note:**

4. The  $I_O$  maximum rating must be observed.

## Recommended Operating Conditions

The Recommended Operating Conditions table defines the conditions for actual device operation. Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding them or designing to Absolute Maximum Ratings.

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
$V_{CC}$	Supply Voltage		0.9		3.6	V
$V_{IN}$	Input Voltage <sup>(5)</sup>		0		3.6	V
$V_{OUT}$	Output Voltage	HIGH or LOW State	0		$V_{CC}$	V
		$V_{CC}=0V$	0		3.6	
$I_{OH} / I_{OL}$	Output Current in $I_{OH} / I_{OL}$	$V_{CC}=3.0V$ to $3.6V$		±2.6		mA
		$V_{CC}=2.3V$ to $2.7V$		±2.1		
		$V_{CC}=1.65V$ to $1.95V$		±1.5		
		$V_{CC}=1.40V$ to $1.60V$		±1.0		
		$V_{CC}=1.10V$ to $1.30V$		±0.5		
		$V_{CC}=0.9V$		20.0		µA
$T_A$	Free Air Operating Temperature		-40		+85	°C
$\Delta t / \Delta V$	Minimum Input Edge Rate	$V_{IN}=0.8V$ to $2.0V$ , $V_{CC}=3.0V$		10		ns/V
$\theta_{JA}$	Thermal Resistance	SC70-5		425		°C/W
		MicroPak™-6		500		
		MicroPak2™-6		560		

**Note:**

5. Unused inputs must be held HIGH or LOW. They may not float.

### DC Electrical Characteristics

Symbol	Parameter	Conditions	V <sub>CC</sub> (V)	T <sub>A</sub> =+25°C		T <sub>A</sub> =-40°C to +85°C		Units
				Min.	Max.	Min.	Max.	
V <sub>P</sub>	Positive Threshold Voltage		0.90	0.30	0.60	0.30	0.60	V
			1.10	0.40	1.00	0.40	1.00	
			1.40	0.50	1.20	0.50	1.20	
			1.65	0.70	1.50	0.70	1.50	
			2.30	1.00	1.90	1.00	1.90	
			3.00	1.50	2.60	1.50	2.60	
V <sub>N</sub>	Negative Threshold Voltage		0.90	0.10	0.60	0.10	0.60	V
			1.10	0.15	0.70	0.15	0.70	
			1.40	0.20	0.80	0.20	0.80	
			1.65	0.25	0.90	0.25	0.90	
			2.30	0.40	1.15	0.40	1.15	
			3.00	0.6	1.50	0.60	1.50	
V <sub>H</sub>	Hysteresis Voltage		0.90	0.07	0.50	0.07	0.50	V
			1.10	0.08	0.60	0.08	0.60	
			1.40	0.09	0.80	0.09	0.80	
			1.65	0.10	1.00	0.10	1.00	
			2.30	0.25	1.10	0.25	1.10	
			3.00	0.60	1.80	0.60	1.80	
V <sub>OH</sub>	HIGH Level Output Voltage	I <sub>OH</sub> =-20μA	0.90	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		V
			1.10 ≤ V <sub>CC</sub> ≤ 1.30	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		
			1.40 ≤ V <sub>CC</sub> ≤ 1.60	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		
			1.65 ≤ V <sub>CC</sub> ≤ 1.95	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		
			2.30 ≤ V <sub>CC</sub> ≤ 2.70	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		
			3.00 ≤ V <sub>CC</sub> ≤ 3.60	V <sub>CC</sub> - 0.1		V <sub>CC</sub> - 0.1		
		I <sub>OH</sub> =-0.5mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30	0.75 x V <sub>CC</sub>		0.70 x V <sub>CC</sub>		
		I <sub>OH</sub> =-1mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60	1.07		0.99		
		I <sub>OH</sub> =-1.5mA	1.65 ≤ V <sub>CC</sub> ≤ 1.95	1.24		1.22		
		I <sub>OH</sub> =-2.1mA	2.30 ≤ V <sub>CC</sub> ≤ 2.70	1.95		1.87		
I <sub>OH</sub> =-2.6mA	3.00 ≤ V <sub>CC</sub> ≤ 3.60	2.61		2.55				
V <sub>OL</sub>	LOW Level Output Voltage	I <sub>OL</sub> =20μA	0.90		0.1		0.1	V
			1.10 ≤ V <sub>CC</sub> ≤ 1.30		0.1		0.1	
			1.40 ≤ V <sub>CC</sub> ≤ 1.60		0.1		0.1	
			1.65 ≤ V <sub>CC</sub> ≤ 1.95		0.1		0.1	
			2.30 ≤ V <sub>CC</sub> ≤ 2.70		0.1		0.1	
			3.00 ≤ V <sub>CC</sub> ≤ 3.60		0.1		0.1	
		I <sub>OL</sub> =0.5mA	1.10 ≤ V <sub>CC</sub> ≤ 1.30		0.30 x V <sub>CC</sub>		0.30 x V <sub>CC</sub>	
		I <sub>OL</sub> =1mA	1.40 ≤ V <sub>CC</sub> ≤ 1.60		0.31		0.37	
		I <sub>OL</sub> =1.5mA	1.65 ≤ V <sub>CC</sub> ≤ 1.95		0.31		0.35	
		I <sub>OL</sub> =2.1mA	2.30 ≤ V <sub>CC</sub> ≤ 2.70		0.31		0.33	
I <sub>OL</sub> =2.6mA	3.00 ≤ V <sub>CC</sub> ≤ 3.60		0.31		0.33			
I <sub>IN</sub>	Input Leakage Current	0 ≤ V <sub>IN</sub> ≤ 3.6V	0.90 to 3.60		±0.1		±0.5	μA
I <sub>OFF</sub>	Power Off Leakage Current	0 ≤ (V <sub>IN</sub> , V <sub>O</sub> ) ≤ 3.6V	0		0.5		0.5	μA
I <sub>CC</sub>	Quiescent Supply Current	V <sub>IN</sub> =V <sub>CC</sub> or GND	0.90 to 3.60		0.9		0.9	μA

### AC Electrical Characteristics

Symbol	Parameter	Conditions	V <sub>CC</sub>	T <sub>A</sub> =25°C			T <sub>A</sub> =-40 to 85°C		Units	
				Min.	Typ.	Max.	Min.	Max.		
t <sub>PHL</sub> , t <sub>PLH</sub>	Propagation Delay	C <sub>L</sub> =10pF, R <sub>L</sub> =1MΩ	0.90		27.0				ns	
			1.10 ≤ V <sub>CC</sub> ≤ 1.30	3.5	11.0	21.8	3.0	34.3		
			1.40 ≤ V <sub>CC</sub> ≤ 1.60	2.5	7.0	14.8	2.0	15.0		
			1.65 ≤ V <sub>CC</sub> ≤ 1.95	2.0	6.0	12.0	1.5	12.2		
			2.30 ≤ V <sub>CC</sub> ≤ 2.70	1.5	5.0	9.4	1.0	9.9		
			3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.0	4.0	8.3	1.0	9.0		
		C <sub>L</sub> =15pF, R <sub>L</sub> =1MΩ	0.90		30.0					
			1.10 ≤ V <sub>CC</sub> ≤ 1.30	4.0	11.0	22.8	3.5	37.3		
			1.40 ≤ V <sub>CC</sub> ≤ 1.60	3.0	8.0	15.5	2.5	16.5		
			1.65 ≤ V <sub>CC</sub> ≤ 1.95	2.5	6.0	12.6	2.0	13.6		
			2.30 ≤ V <sub>CC</sub> ≤ 2.70	2.0	5.0	9.9	1.5	10.8		
			3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.5	4.0	8.7	1.0	9.5		
		C <sub>L</sub> =30pF, R <sub>L</sub> =1MΩ	0.90		32.0					
			1.10 ≤ V <sub>CC</sub> ≤ 1.30	5.0	13.0	25.9	4.0	46.3		
			1.40 ≤ V <sub>CC</sub> ≤ 1.60	4.0	9.0	17.8	3.5	18.2		
			1.65 ≤ V <sub>CC</sub> ≤ 1.95	3.0	7.0	14.4	2.0	15.9		
			2.30 ≤ V <sub>CC</sub> ≤ 2.70	2.0	6.0	11.3	1.5	12.8		
			3.00 ≤ V <sub>CC</sub> ≤ 3.60	1.5	5.0	9.2	1.0	10.7		
C <sub>IN</sub>	Input Capacitance		0		2			pF		
C <sub>PD</sub>	Power Dissipation Capacitance	V <sub>IN</sub> =0V or V <sub>CC</sub> , f=10MHz	0.90 to 3.60		8				pF	

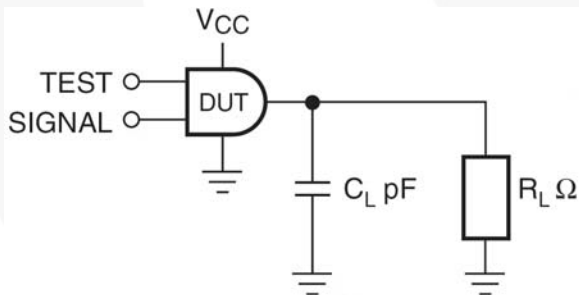


Figure 5. AC Test Circuit

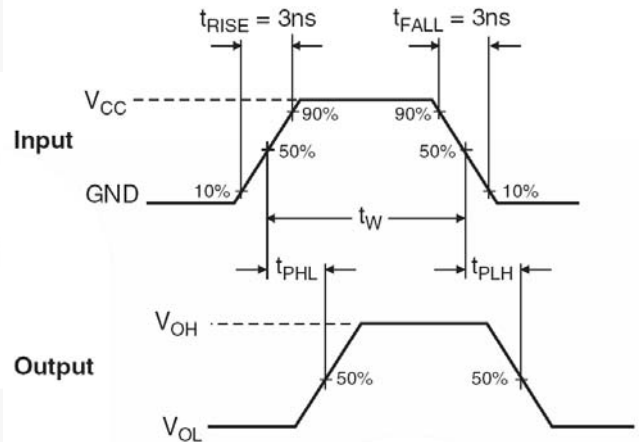
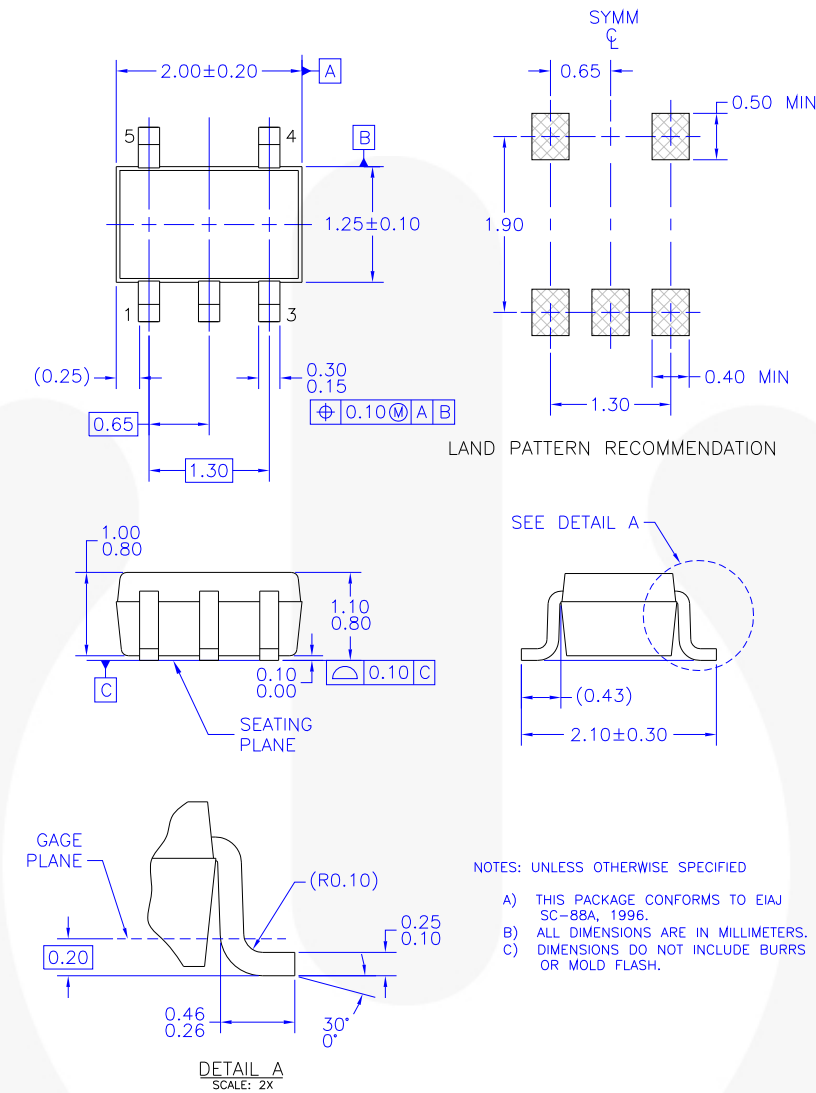


Figure 6. AC Waveforms for Inverting and Non-Inverting Functions

Symbol	V <sub>CC</sub>					
	3.3V ± 0.3V	2.5V ± 0.2V	1.8V ± 0.15V	1.5V ± 0.1V	1.2V ± 0.1V	0.9V
V <sub>mi</sub>	1.5V	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2
V <sub>mo</sub>	1.5V	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2	V <sub>CC</sub> / 2

## Physical Dimensions



MAA05AREV5

**Figure 7. 5-Lead, SC70, EIAJ SC-88a, 1.25mm Wide**

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### Tape and Reel Specification

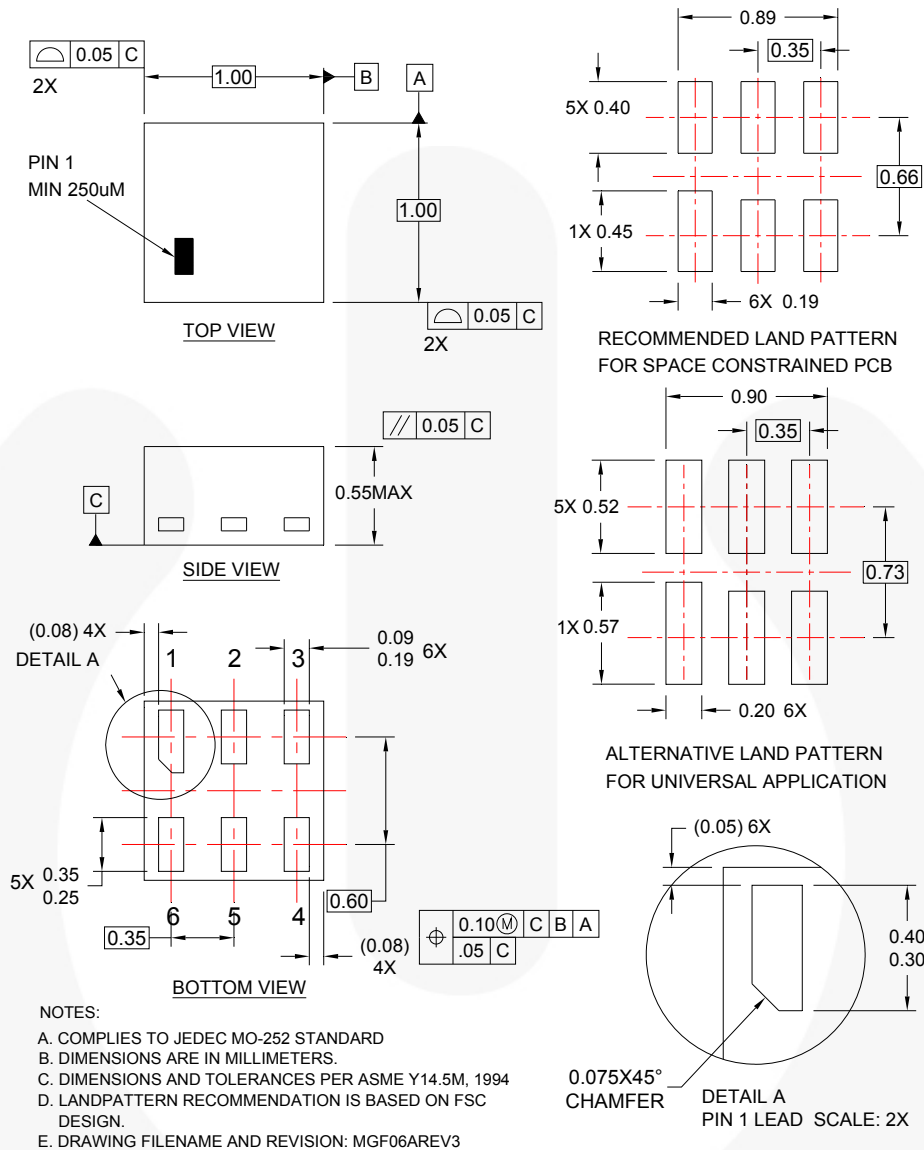
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[http://www.fairchildsemi.com/products/analog/pdf/sc70-5\\_tr.pdf](http://www.fairchildsemi.com/products/analog/pdf/sc70-5_tr.pdf)

Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
P5X	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	3000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed





## Physical Dimensions



**Figure 9. 6-Lead, MicroPak2™, 1x1mm Body, .35mm Pitch**

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Package Designator	Tape Section	Cavity Number	Cavity Status	Cover Type Status
FHX	Leader (Start End)	125 (Typical)	Empty	Sealed
	Carrier	5000	Filled	Sealed
	Trailer (Hub End)	75 (Typical)	Empty	Sealed



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Dual Cool™	MICROCOUPLER™	SignalWise™	TinyWire™
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Counterfeiting of semiconductor parts is a growing problem in the industry. All manufacturers of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed applications, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handling and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address any warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

**PRODUCT STATUS DEFINITIONS**

**Definition of Terms**

Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.

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